

# **AlGaAs/GaAs T-1 PACKAGE INFRARED EMITTING DIODE**

**MIE-334A4**

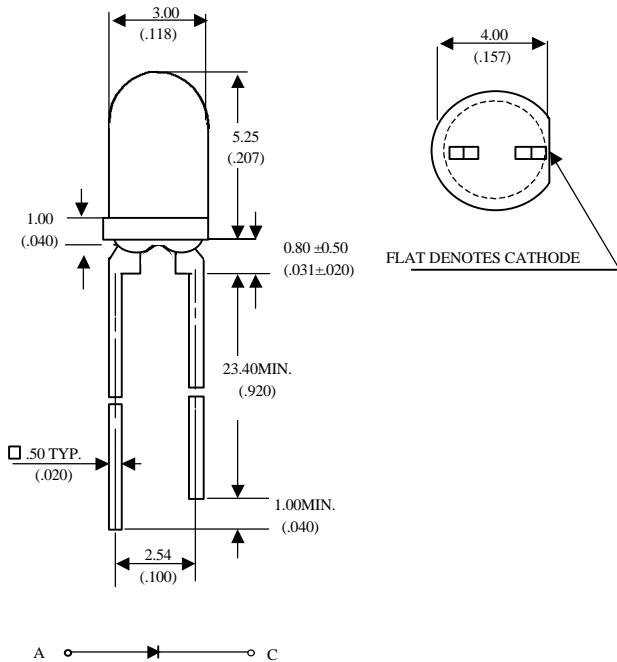
## **Description**

The MIE-334A4 is an infrared emitting diode utilizing GaAs with AlGaAs window coating chip technology.

It is molded in water clear plastic package.

## **Package Dimensions**

Unit : mm (inches )



## **Features**

- High radiant power and high radiant intensity
- Suitable for DC and high pulse current operation
- Standard T-1 (  $\phi$  3mm ) package
- Peak wavelength  $\lambda_p = 940$  nm
- Good spectral matching to si-photodetector
- Radiant angle :  $\pm 15^\circ$

### Notes :

1. Tolerance is  $\pm 0.25$  mm (.010") unless otherwise noted.
2. Protruded resin under flange is 0.4 mm (.0157") max.
3. Lead spacing is measured where the leads emerge from the package.

## **Absolute Maximum Ratings**

@  $T_A=25^\circ\text{C}$

Parameter	Maximum Rating	Unit
Power Dissipation	120	mW
Peak Forward Current(300pps,10μs pulse)	1	A
Continuos Forward Current	100	mA
Reverse Voltage	5	V
Operating Temperature Range	-55°C to +100°C	
Storage Temperature Range	-55°C to +100°C	
Lead Soldering Temperature	260°C for 5 seconds	



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**Optical-Electrical Characteristics**

 @  $T_A=25^\circ C$ 

Parameter	Test Conditions	Symbol	Min.	Typ .	Max.	Unit
Radiant Intensity	$I_F=20mA$	$I_e$	-	2.2	-	mW/sr
Forward Voltage	$I_F=50mA$	$V_F$	-	1.3	1.5	V
Reverse Current	$V_R=5V$	$I_R$	-	-	100	$\mu A$
Peak Wavelength	$I_F=20mA$	$\lambda_p$	-	940	-	nm
Spectral Bandwidth	$I_F=20mA$	$\Delta\lambda$	-	50	-	nm
View Angle	$I_F=20mA$	$2\theta_{1/2}$	-	30	-	deg .

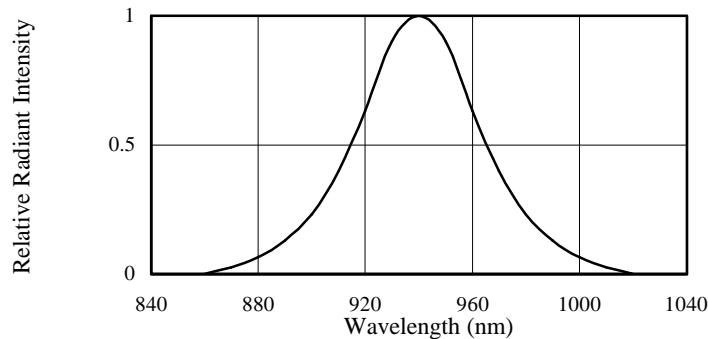
**Typical Optical-Electrical Characteristic Curves**


FIG.1 SPECTRAL DISTRIBUTION

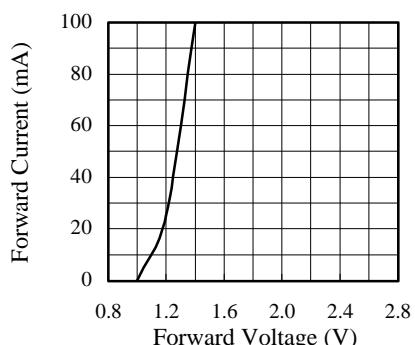
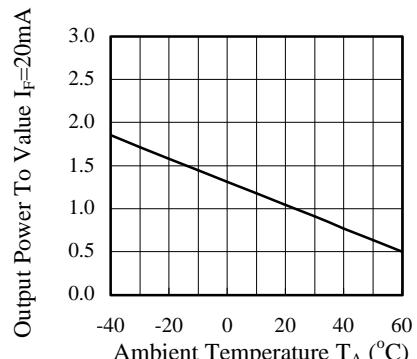
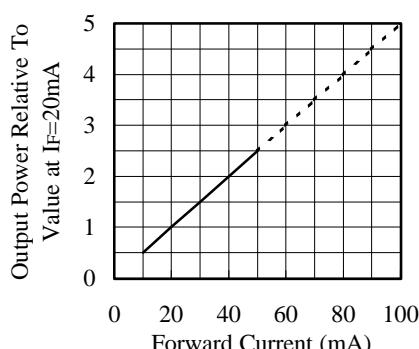
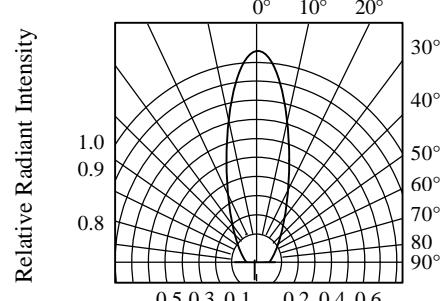

 FIG.2 FORWARD CURRENT VS.  
FORWARD VOLTAGE

 FIG.3 RELATIVE RADIANT INTENSITY  
VS. AMBIENT TEMPERATURE

 FIG.4 RELATIVE RADIANT INTENSITY  
VS. FORWARD CURRENT


FIG.5 RADIATION DIAGRAM